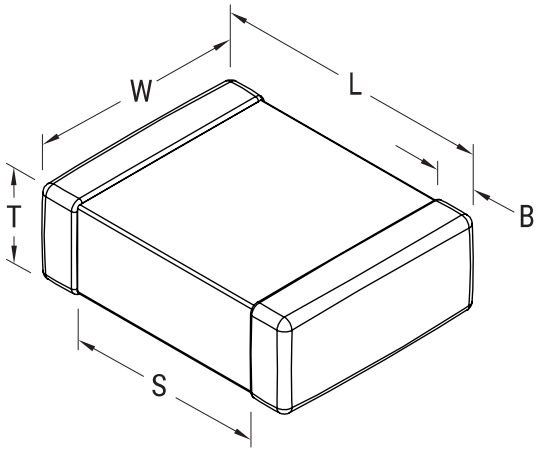
C1210C249C3HAC7210

SMD Comm X8R HT150C, Ceramic, 2.4 pF, +/-0.25 pF, 25 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 1210 / 3225



Click here for the 3D model.

General Information	
Series	SMD Comm X8R HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	40 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
T	0.78mm +/-0.10mm
S	1.5mm MIN
B	0.5mm +/-0.25mm
Case Code (EIA / mm)	1210 / 3225

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000

Specifications	
Capacitance	2.4 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	+/-0.25 pF
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1MegaHz 1.0Vrms
Dissipation Factor	2.5% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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